

SPECIFICATIONS FOR LCD MODULE



MODEL NO.
BG12864AFPHWn207d\$
VER.01

FOR MESSRS:

ON DATE OF:

APPROVED BY:

BOLYMIN, INC.

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1. Numbering System

<u>B</u>	<u>G</u>	<u>12864</u>	<u>A</u>	<u>E</u>	<u>P</u>	<u>H</u>	<u>-</u>	<u>W</u>	<u>n207d\$</u>
0	1	2	3	4	5	6	7	8	9

0	Brand	Bolymin	
1	Module Type	C= character type G= graphic type P= TAB/TCP type	O= COG type F= COF type L=PLED/OLED
2	Format	2002=20 characters, 2 lines 12232= 122 x 32 dots	
3	Version No.	A type	
4	LCD Color	G=STN/gray Y=STN/yellow-green PLED/yellow-green C=color STN,OLED/RGB	B=STN/blue,OLED/blue F=FSTN T=TN
5	LCD Type	R=positive/reflective P=positive/transflective	M=positive/transmissive N=negative/transmissive
6	Backlight type/color	L=LED array/ yellow-green H=LED edge/white R=LED array/red G=LED edge/yellow-green F=RGB array I=RGB edge Q=LED edge/red N=No backlight	D=LED edge/blue E=EL/white B=EL/blue C=CCFL/white Y=LED Bottom/yellow O=LED array/orange K=LED edge/green A=LED edge/amber
7	CGRAM Font (applied only on character type)	J=English/Japanese Font E=English/European Font G=Chinese(simple) F=Chinese(traditional)	C=English/Cyrillic Font H=English/Hebrew Font A=English/Arabic Font
8	View Angle/ Operating Temperature	B=Bottom/Normal Temperature H=Bottom/Wide Temperature U=Bottom/Ultra wide Temperature	T=Top/Normal Temperature W=Top/Wide Temperature C=9H/Normal Temperature E=Top/ultra wide temperature
9	Special Code	3=3.3 volt logic power supply n=negative voltage for LCD c=cable/connector 207d=AVANT IC	t=temperature compensation for LCD p=touch panel \$=RoHS

2. Handling Precaution

2.1 Precaution in use of LCD Module

- 2.1.1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure and/or sharp tools on the surface of display area.
- 2.1.2. The polarizer placed on the display surface is easily scratched and damaged. Extreme care should be taken when handling it. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isopropyl alcohol, ethyl alcohol, do not use water, ketone or aromatics to clear display surface, and never scrub it hard.
- 2.1.3. Keep LCD panels away from direct sunlight. The storage environment should be dust-free, clean, dry, temperature is $25^{\circ}\text{C} \pm 10^{\circ}\text{C}$ and the humidity is below 55% RH.
- 2.1.4. Do not input any signal before power is turned on.
- 2.1.5. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 2.1.6. It's important to control soldering temperature and time. RoHS compliant materials might need higher temperature and time, but try to keep temperature under 350°C and time in 3-5 sec.
- 2.1.7. EL is manufactured from the organic film, and is easily affected by temperature, humidity and other environmental impact. Long time storage might cause low quality of the case. Therefore, please start production in 3 months after reception of the LCM. If in any case, long time storage over 3 months is necessary, please keep EL in vacuum package or at least in humidity $< 35\%$ RH, and temperature $25^{\circ}\text{C} \pm 10^{\circ}\text{C}$.
Note: 2.1.7. is applied to EL backlight only.

2.2 Static Electricity Precautions:

- 2.2.1. The LCD module contains a C-MOS LSI. People who operate the LCM should wear ESD protection equipment to prevent ESD hurt on products.
- 2.2.2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 2.2.3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 2.2.4. The modules should be kept in anti-static bags or trays for storage.
- 2.2.5. Only properly grounded soldering irons should be used.
- 2.2.6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 2.2.7. The normal static prevention measures should be observed for work clothes and working benches.
- 2.2.8. Since dry air(almost low RH) is inductive to static, a humidity of 50-60% RH is recommended in assembly line.

2.3 Operation Precautions:

- 2.3.1. DC voltage applied on LCM causes electrochemical reactions, which will deteriorate the display over time. The applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 2.3.2. LCD driving voltage should be kept within specified range; excess voltage will shorten display life, while less voltage may not turn on LCM.
- 2.3.3. LCM response time will be extremely delayed in low operating temperature(such as -20°C) than in room operating temperature. Therefore, higher LCD driving voltage is required in low operating temperature; On the other hand, in high operating temperature (such as $+70^{\circ}\text{C}$) LCD shows dark background color, therefore lower LCD driving voltage is required. Be sure to use the specified LCD driving voltage in different operating temperature.

2.4 Safety:

- 2.4.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

2.5 WARRANTY POLICY

Bolymin .Will provide one-year warranty for the products only if under specification operating conditions.

If there are functional defects found during the period of warranty, the defective products would be replaced on a one-to-one basis.

Bolymin would not be responsible for any direct/indirect liabilities consequential to any parties.

2.6 MTBF

- 2.6.1 .By specific test condition, MTBF based on 30°C normal operation temperature is 50,000hours.

2.6.2 Test Condition:

2.6.2.1 Supply Voltage for LCM: Typical Vdd

2.6.2.2 CC (Constant Current) mode and typical current is applied for LED.

2.6.2.3 Run-Patterns: by Bolymin's test program that has defined patterns and cyclic period.

2.6.2.4 Humidity: 60%RH

2.6.3 Test Criteria:

Attenuation of average brightness: $\leq 50\%$

Increasing of current consumption for LCM/Backlight: $\leq 20\%$

Display function at room temperature: Normal

Appearance: Normal

3. General Specification

(1) Mechanical Dimension

Item	Standard Value	Unit
Number of dots	128×64	dots
Module dimension (L*W*H)	93.0×70.0×13.1-LEDB/L	mm
View area	72(W)×40(H)	mm
Active area	66.52(W)×33.24(H)	mm
Dot size	0.48(W)×0.48(H)	mm
Dot pitch	0.52(W)×0.52(H)	mm

(2) Controller IC: AVANT SBN6400G+SBN0064G

4. Absolute Maximum Rating

4.1 Electrical Absolute Maximum Ratings

(V_{SS}=0V, Ta=25°C)

Item	Symbol	Min	Typ	Max	Unit
Input Voltage	V _I	0	—	V _{CC}	V
Supply Voltage For Logic	V _{CC}	0	—	6.7	V
Supply Voltage For LCD	V _{CC} -V _{LCD}	0	—	16.7	V

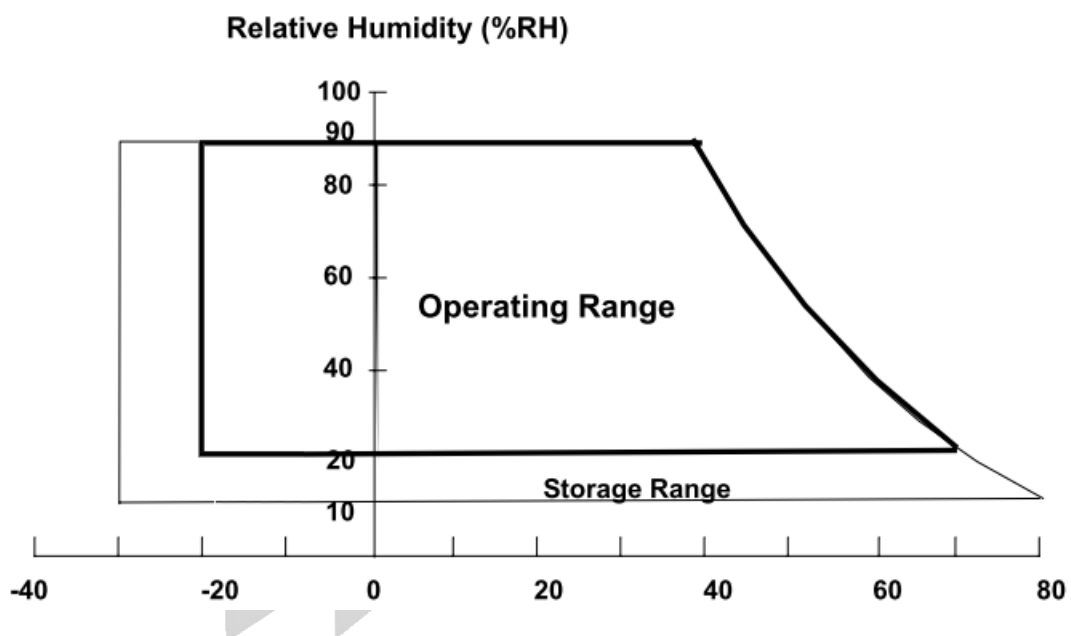
4.2 Environmental Absolute Maximum Ratings

Item	Symbol	Min	Max	Unit	Note
Operating Temperature	TOP	-20	70	°C	(1)
Storage Temperature	TST	-30	80	°C	(1) 、 (2)

Note (1)

- (a) 90 %RH Max. ($T_a \leq 40\text{ °C}$).
- (b) Wet-bulb temperature should be 39 °C Max. ($T_a > 40\text{ °C}$).
- (c) No condensation.

Note (2) The temperature of panel surface should be -20 °C min. and 70 °C max.



5. Electrical Characteristics

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Supply Voltage For Logic	$V_{DD}-V_{SS}$	—	4.75	5.0	5.25	V
Supply Voltage For LCD	$V_{DD}-V_0$	$T_a=25^{\circ}\text{C}$	8.5	8.8	9.1	V
Input High Vol	V_{IH}	—	$V_{DD}-2.2$	—	V_{DD}	V
Input Low Vol	V_{IL}	—	0	—	0.8	V
Output High Vol	V_{OH}	—	$V_{DD}-0.3$	—	V_{DD}	V
Output Low Vol.	V_{OL}	—	0	—	0.3	V
Supply Current	I_{DD}	$V_{DD}=5\text{V}$	—	5	—	mA
LCM Surface Luminance $T_a=25^{\circ}\text{C}$	L	$I_{LED}=60\text{mA}$ Display all OFF	65	97	—	cd/m^2

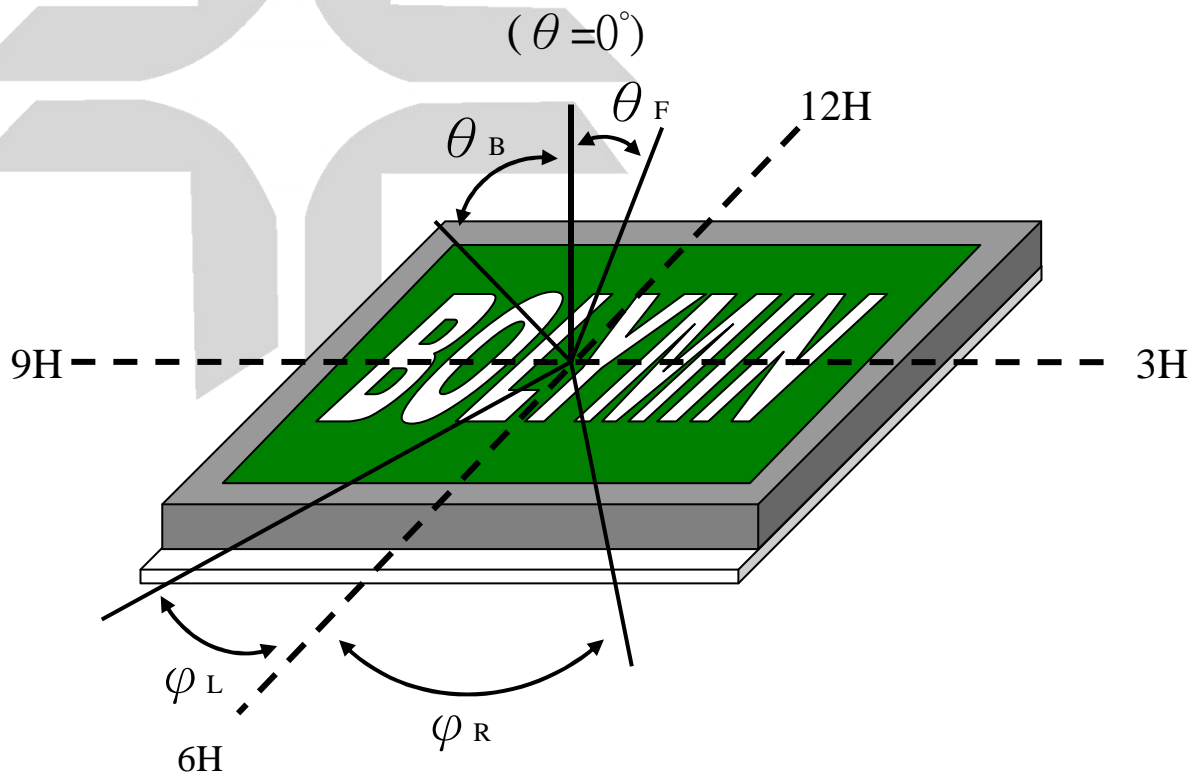
※Optimum LCD driving voltage value, referring to above mentioned range, is changed due to different batch of LCD glass.

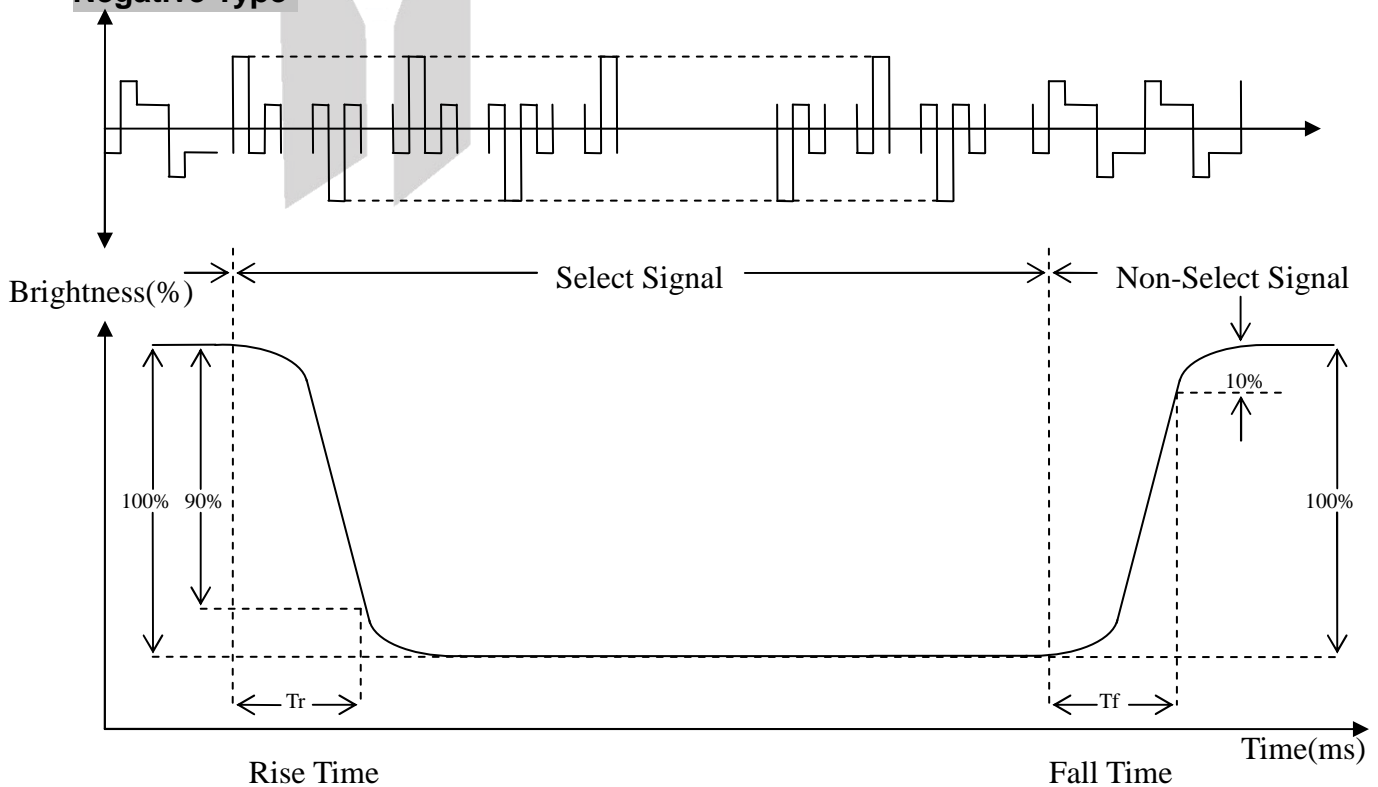
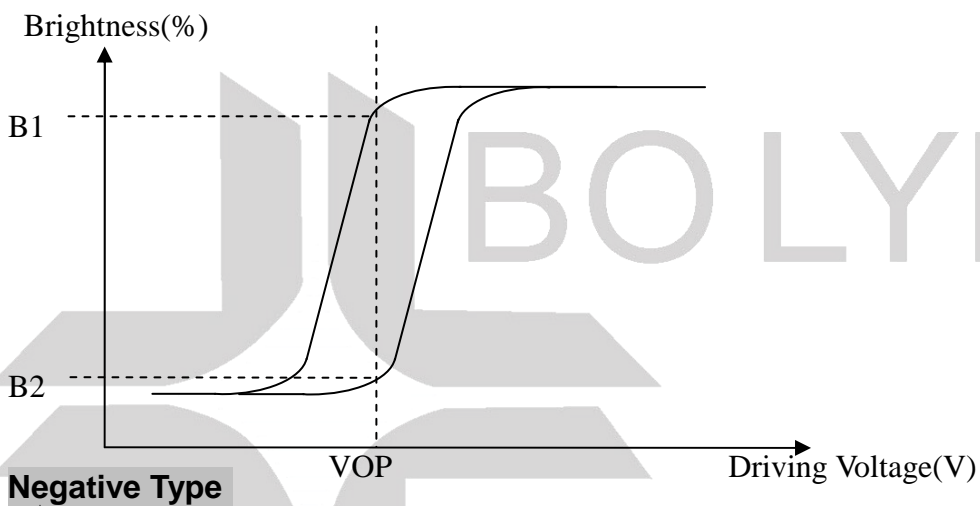
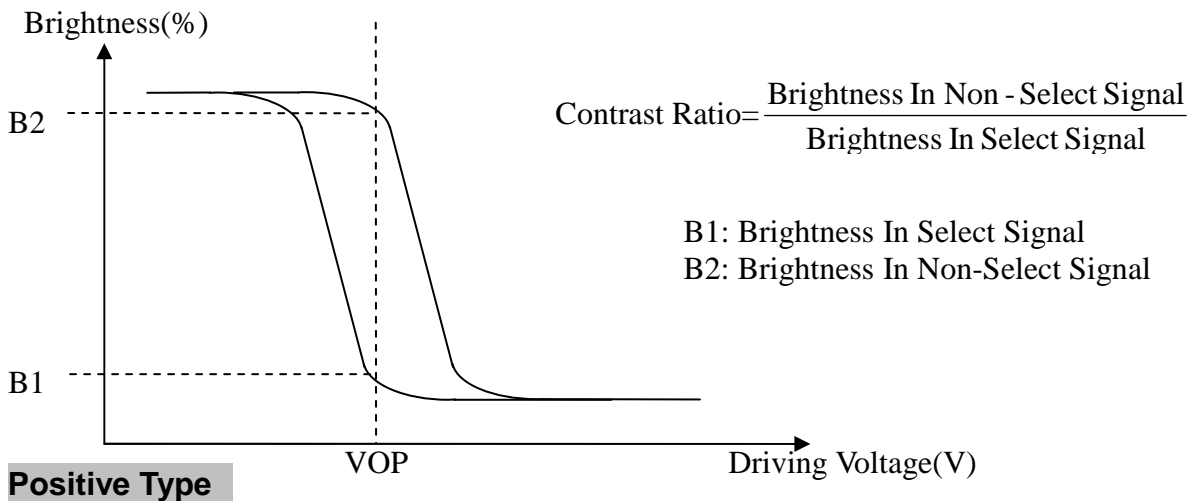
6. Optical Characteristics

a. FSTN

(Ta=25°C)

Item	Symbol	Min.	Typ.	Max.	Unit
View Angle (CR>=2)	θ_F	-	48	-	deg
	θ_B	-	50	-	deg
	φ_L	-	50	-	deg
	φ_R	-	45	-	deg
Contrast Ratio	CR	2	5	-	-
Response Time 25°C	T rise	-	200	400	ms
	T fall	-	250	400	ms



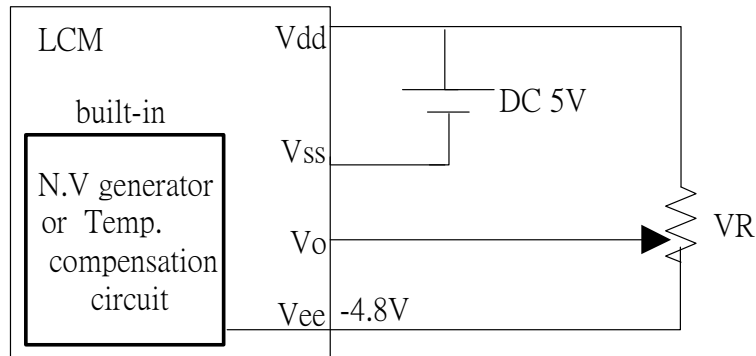


7. Interface Pin Function

Pin No.	Symbol	Level	Description
1	V _{ss}	0V	Ground
2	V _{dd}	5.0V	Supply voltage for logic
3	V _O	(Variable)	Operating voltage for LCD
4	D/I	H/L	H: Data , L: Instruction
5	R/W	H/L	H: Read(MPU←Module) , L :Write(MPU→Module)
6	E	H	Enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	CS1	L	Chip Select for IC1
16	CS2	L	Chip Select for IC2
17	/RST	L	Reset signal
18	V _{ee}		Negative Voltage output -4.8V
19	A	—	Power supply for B/L (+)
20	K	—	Power supply for B/L (GND)

8. Power supply for LCD Module and LCD operating voltage adjustment

* LCM operating on " DC 5V " input with built-in negative voltage



9. Backlight information

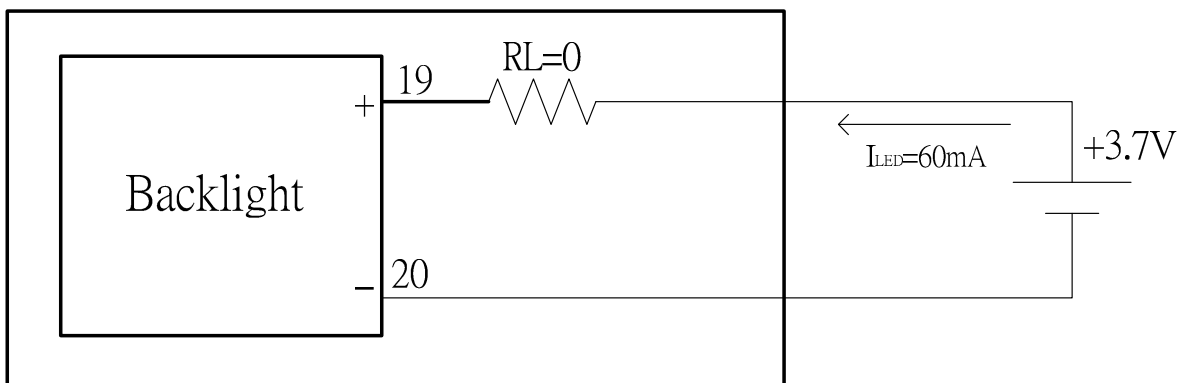
(1) LED edge/ White

Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Supply Current	I _{LED}	—	60	—	mA	V=3.7V
Supply Voltage	V	3.4	3.7	4.0	V	I _{LED} =60mA
Reverse Voltage	V _R	—	—	5	V	—
CIE	X	0.27	—	0.32		I _{LED} =60mA
	Y	0.27	—	0.32		
Color	White					

(2) Backlight driving methods

- a. LED B/L drive from pin19 (LED+) pin20 (LED-)
 - a.1 edge/ White

LCM



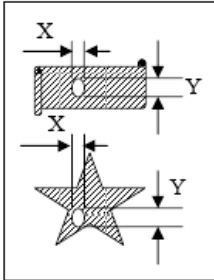
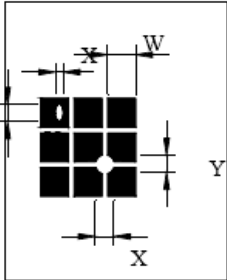
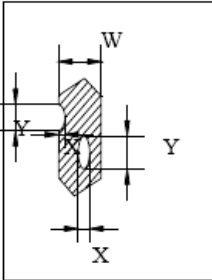
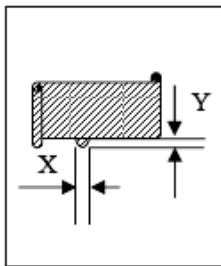
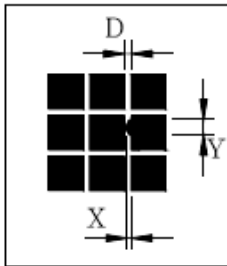
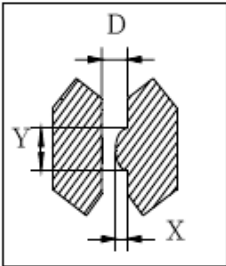
10. Quality Assurance

10.1 Inspection conditions

1. The LCD shall be inspected under 20~40W white fluorescent light.
2. Checking Direction shall be in the 40 degree from perpendicular line of specimen surface.
3. Checker shall see over 30 cm.
4. Inspect about 5 seconds for each side.
5. Defect that is located at outside of VA and doesn't affect function is ignored.

10.2 Inspection Parameters

NO.	Parameter	Criteria																								
1	Black or White spots (Particle)	<table><tr><th colspan="2">Zone Dimension</th><th>Acceptable Number</th><th>Class Of Defects</th><th>Acceptable Level</th></tr><tr><td colspan="2">D≤0.10</td><td>Disregard</td><td rowspan="4">Minor</td><td rowspan="4">2.5</td></tr><tr><td colspan="2">0.10<D≤0.2</td><td>4</td></tr><tr><td colspan="2">0.2<D≤0.3</td><td>2</td></tr><tr><td colspan="2">0.3<D</td><td>0</td></tr></table>				Zone Dimension		Acceptable Number	Class Of Defects	Acceptable Level	D≤0.10		Disregard	Minor	2.5	0.10<D≤0.2		4	0.2<D≤0.3		2	0.3<D		0		
		Zone Dimension		Acceptable Number	Class Of Defects	Acceptable Level																				
		D≤0.10		Disregard	Minor	2.5																				
		0.10<D≤0.2		4																						
		0.2<D≤0.3		2																						
		0.3<D		0																						
D=(Long + Short)/2																										
Total defects should not exceed 5/module																										
Defect that is located at outside of AA and doesn't affect function is ignored.																										
2	Scratch, Substances	<table><tr><th colspan="2">Zone</th><th rowspan="2">Acceptable Number</th><th rowspan="2">Class Of Defects</th><th rowspan="2">Acceptable Level</th></tr><tr><th>X(mm)</th><th>Y(mm)</th></tr><tr><td>—</td><td>0.05≥W</td><td>Disregard</td><td rowspan="4">Minor</td><td rowspan="4">2.5</td></tr><tr><td>4.0≥L</td><td>0.05≥W</td><td>4</td></tr><tr><td>3.0≥L</td><td>0.1≥W</td><td>2</td></tr><tr><td>—</td><td>0.1<W</td><td>0</td></tr></table>				Zone		Acceptable Number	Class Of Defects	Acceptable Level	X(mm)	Y(mm)	—	0.05≥W	Disregard	Minor	2.5	4.0≥L	0.05≥W	4	3.0≥L	0.1≥W	2	—	0.1<W	0
		Zone		Acceptable Number	Class Of Defects	Acceptable Level																				
		X(mm)	Y(mm)																							
		—	0.05≥W	Disregard	Minor	2.5																				
		4.0≥L	0.05≥W	4																						
		3.0≥L	0.1≥W	2																						
—	0.1<W	0																								
X: Length Y: Width																										
Total defects should not exceed 5/module																										
Defect that is located at outside of AA and doesn't affect function is ignored.																										

3	Air Bubbles (between glass & polarizer)	<table><tr><th>Zone Dimension</th><th>Acceptable Number</th><th>Class Of Defects</th><th>Acceptable Level</th></tr><tr><td>$D \leq 0.2$</td><td>Disregard</td><td rowspan="3">Minor</td><td rowspan="3">2.5</td></tr><tr><td>$0.2 < D \leq 0.5$</td><td>3</td></tr><tr><td>$0.5 < D$</td><td>0</td></tr></table> <p>Total defects shall not excess 3/module. Defect that is located at outside of AA and doesn't affect function is ignored. Bobbie is sawn only under reflection light is disregarded.</p>	Zone Dimension	Acceptable Number	Class Of Defects	Acceptable Level	$D \leq 0.2$	Disregard	Minor	2.5	$0.2 < D \leq 0.5$	3	$0.5 < D$	0														
Zone Dimension	Acceptable Number	Class Of Defects	Acceptable Level																									
$D \leq 0.2$	Disregard	Minor	2.5																									
$0.2 < D \leq 0.5$	3																											
$0.5 < D$	0																											
4	Displaying Pattern	<p>1. Incomplete or broken line is not allowed. 2. Pinholes</p> <table><tr><th>Dimension Φ(mm)</th><th>Criteria</th><th>Class Of Defects</th><th>Acceptable Level</th></tr><tr><td>$\Phi < 0.1$</td><td>Disregard</td><td rowspan="4">Minor</td><td rowspan="4">2.5</td></tr><tr><td>$0.1 < \Phi \leq 0.2$</td><td>2</td></tr><tr><td>$0.2 < \Phi \leq 0.25$</td><td>1</td></tr><tr><td>$0.25 < \Phi$</td><td>0</td></tr></table> <div></div> <p>$\varnothing = (X+Y)/2$</p> <p>3. Deformation</p> <table><tr><th>Dimension Φ(mm)</th><th>Criteria</th><th>Class Of Defects</th><th>Acceptable Level</th></tr><tr><td>$\Phi < 0.15$</td><td>Disregard</td><td rowspan="3">Minor</td><td rowspan="3">2.5</td></tr><tr><td>$\Phi \leq 0.25$ and $X \leq 1/2D$</td><td>3</td></tr><tr><td>$\Phi > 0.25$ and $X > 1/2D$</td><td>0</td></tr></table> <div></div> <p>D : 間距 $\varnothing = (X+Y)/2$</p>	Dimension Φ (mm)	Criteria	Class Of Defects	Acceptable Level	$\Phi < 0.1$	Disregard	Minor	2.5	$0.1 < \Phi \leq 0.2$	2	$0.2 < \Phi \leq 0.25$	1	$0.25 < \Phi$	0	Dimension Φ (mm)	Criteria	Class Of Defects	Acceptable Level	$\Phi < 0.15$	Disregard	Minor	2.5	$\Phi \leq 0.25$ and $X \leq 1/2D$	3	$\Phi > 0.25$ and $X > 1/2D$	0
Dimension Φ (mm)	Criteria	Class Of Defects	Acceptable Level																									
$\Phi < 0.1$	Disregard	Minor	2.5																									
$0.1 < \Phi \leq 0.2$	2																											
$0.2 < \Phi \leq 0.25$	1																											
$0.25 < \Phi$	0																											
Dimension Φ (mm)	Criteria	Class Of Defects	Acceptable Level																									
$\Phi < 0.15$	Disregard	Minor	2.5																									
$\Phi \leq 0.25$ and $X \leq 1/2D$	3																											
$\Phi > 0.25$ and $X > 1/2D$	0																											

Other Inspection standard reference Bolymin standard.

11. Reliability

■Content of Reliability Test

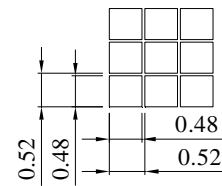
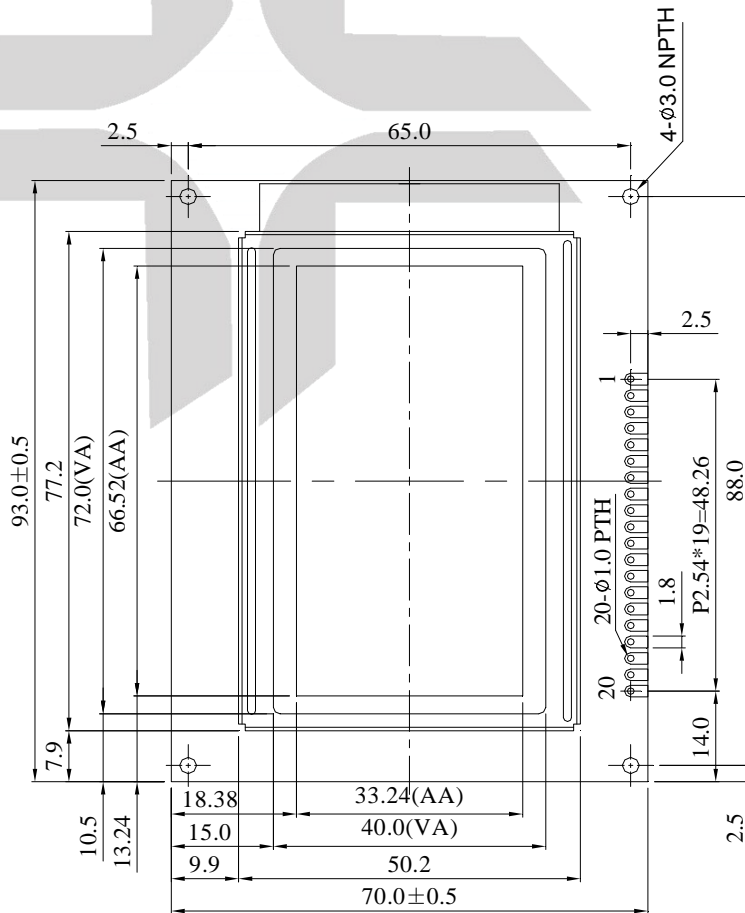
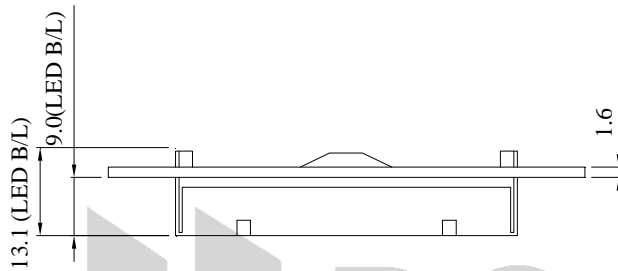
Environmental Test				
No	Test Item	Content of Test	Test Condition	Applicable Standard
1	High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 96 hrs	—
2	Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30℃ 96 hrs	—
3	High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 96 hrs	—
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 96 hrs	—
5	Humidity Test	Endurance test applying the high humidity storage for a long time.	40℃,90%RH 96hrs	—
6	Temperature cycle (Non-operation)	<p>Endurance test applying the low and high temperature cycle.</p> 	-30℃/80℃ 10 cycles	—
7	Vibration test	Endurance test applying the vibration during transportation and using.	<p>Total Fixed Amplitude:1.5mm</p> <p>Vibration Frequency :10~55Hz</p> <p>One cycle 60 seconds to 3 direction of X,Y,Z for each 15minutes</p>	—

※Assess after placing at normal temperature and humidity for 4 hour ◦ No abnormalities in functions and appearance ◦

12. Appendix (Drawing , IC controller data)

12.1 Drawing

PIN NO.	SYMBOL
1	VSS
2	VDD
3	VO
4	D/I
5	R/W
6	E
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	CS1
16	CS2
17	RST
18	VEE
19	A
20	K



DOT SIZE

The non-specified tolerance of dimension is $\pm 0.3\text{mm}$

寶麗明股份有限公司

BOLYMIN, INC.

MODEL
BG12864A

TITLE
LCM DRAWING

DWG NO.

SCALE: 1/1

REV: 0

UNIT: mm

PAGE: 1/1

APPROVE

CHECK

DRAW

Dean 2012.07.06

12.2 IC controller data

12.2.1 Display Control Instruction

The display control instructions control the internal state of the SBN0064G. Instruction is received from MPU to SBN0064G for the display control. The following table shows various instructions.

Instruction	D/I	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function
Display ON/OFF	0	0	0	0	1	1	1	1	1	0/1	Controls the display on or off. Internal status and display RAM data are not affected. 0:OFF, 1:ON
Set Address	0	0	0	1	Y address (0~63)						Sets the Y address in the Y address counter.
Set Page (X address)	0	0	1	0	1	1	1	Page (0 ~7)			Sets the X address at the X address register.
Display Start Line	0	0	1	1	Display start line(0~63)						Indicates the display data RAM displayed at the top of the screen.
Status Read	0	1	B U S Y	0	O N/ O F F	R E S E T	0	0	0	0	Read status. BUSY 0:Ready 1:In operation ON/OFF 0:Display ON 1:Display OFF RESET 0:Normal 1:Reset
Write Display Data	1	0	Display Data								Writes data (DB0:7) into display data RAM. After writing instruction, Y address is increased by 1 automatically.
Read Display Data	1	1	Display Data								Reads data (DB0:7) from display data RAM to the data bus.

Detailed Explanation

Display On/Off

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	1	1	1	1	1	D

The display data appears when D is 1 and disappears when D is 0. Though the data is not on the screen with D = 0, it remains in the display data RAM. Therefore, you can make it appear by changing D = 0 into D = 1.

Display Start Line

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	1	A	A	A	A	A	A

Z address AAAAAA (binary) of the display data RAM is set in the display start line register and displayed at the top of the screen. Figure 2. shows examples of display (1/64 duty cycle) when the start line = 0-3. When the display duty cycle is 1/64 or more (ex. 1/32, 1/24 etc.), the data of total line number of LCD screen, from the line specified by display start line instruction, is displayed.

Set Page (X Address)

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	0	1	1	1	A	A	A

X address AAA (binary) of the display data RAM is set in the X address register. After that, writing or reading to or from MPU is executed in this specified page until the next page is set. See Figure 1.

Set Y Address

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	1	A	A	A	A	A	A

Y address AAAAAA (binary) of the display data RAM is set in the Y address counter. After that, Y address counter is increased by 1 every time the data is written or read to or from MPU.

Status Read

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	0	Busy	0	On/Off	RESET	0	0	0	0

•Busy

When busy is 1, the LSI is executing internal operations. No instruction are accepted while busy is 1, so you should make sure that busy is 0 before writing the next instruction.

•ON/OFF

Shows the liquid crystal display condition: on condition or off condition.

When on/off is 1, the display is in off condition.

When on/off is 0, the display is in on condition.

•RESET

RESET = 1 shows that the system is being initialized. In this condition, no instructions except status read can be accepted.

RESET = 0 shows that initializing has system is in the usual operation condition.

Write Display Data

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	1	D	D	D	D	D	D	D	D

Writes 8-bit data DDDDDDDD (binary) into the display data RAM. The Y address is increased by 1 automatically.

Read Display Data

R/W	D/I	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	1	D	D	D	D	1	D	D	D

Reads out 8-bit data DDDDDDDD (binary) from the display data RAM. Then Y address is increased by 1 automatically.

One dummy read is necessary right after the address setting. For details, refer to the explanation of output register in “Function of Each Block”.

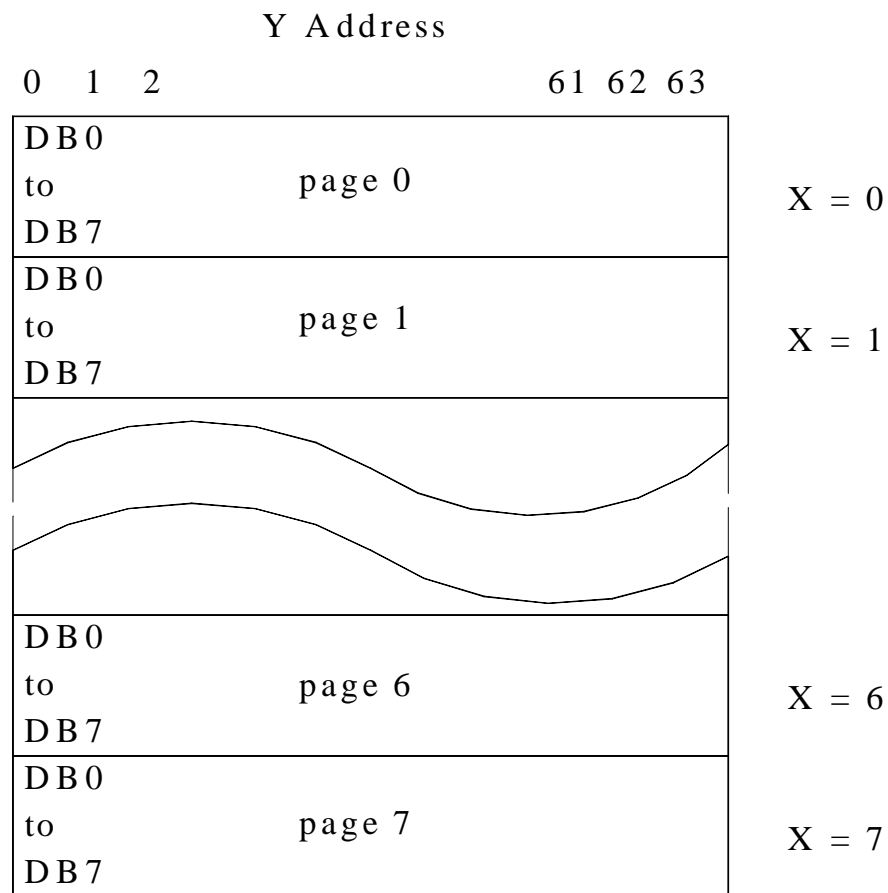
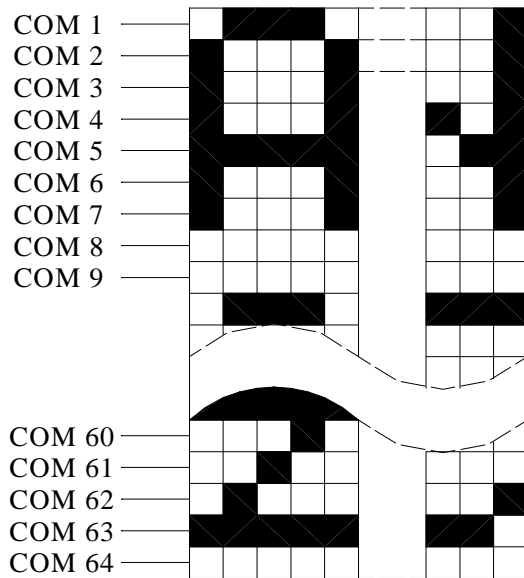
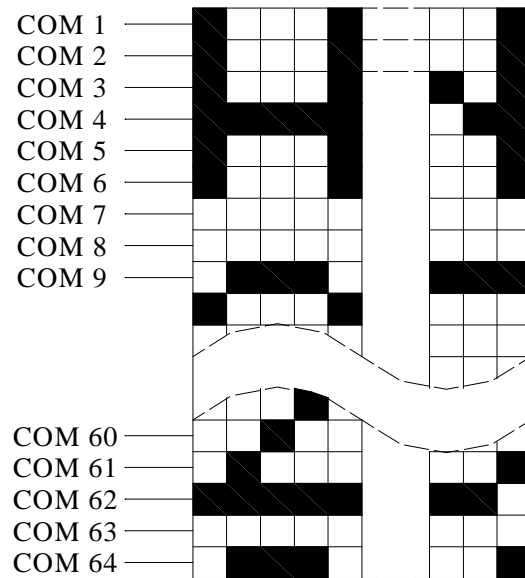


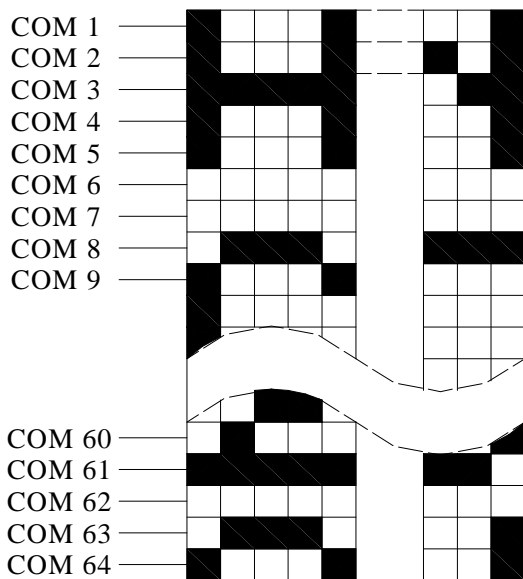
Figure 1



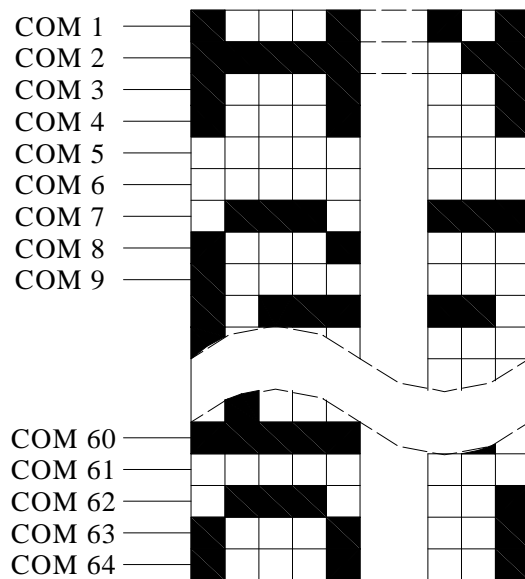
Start line = 0



Start line = 1



Start line = 3



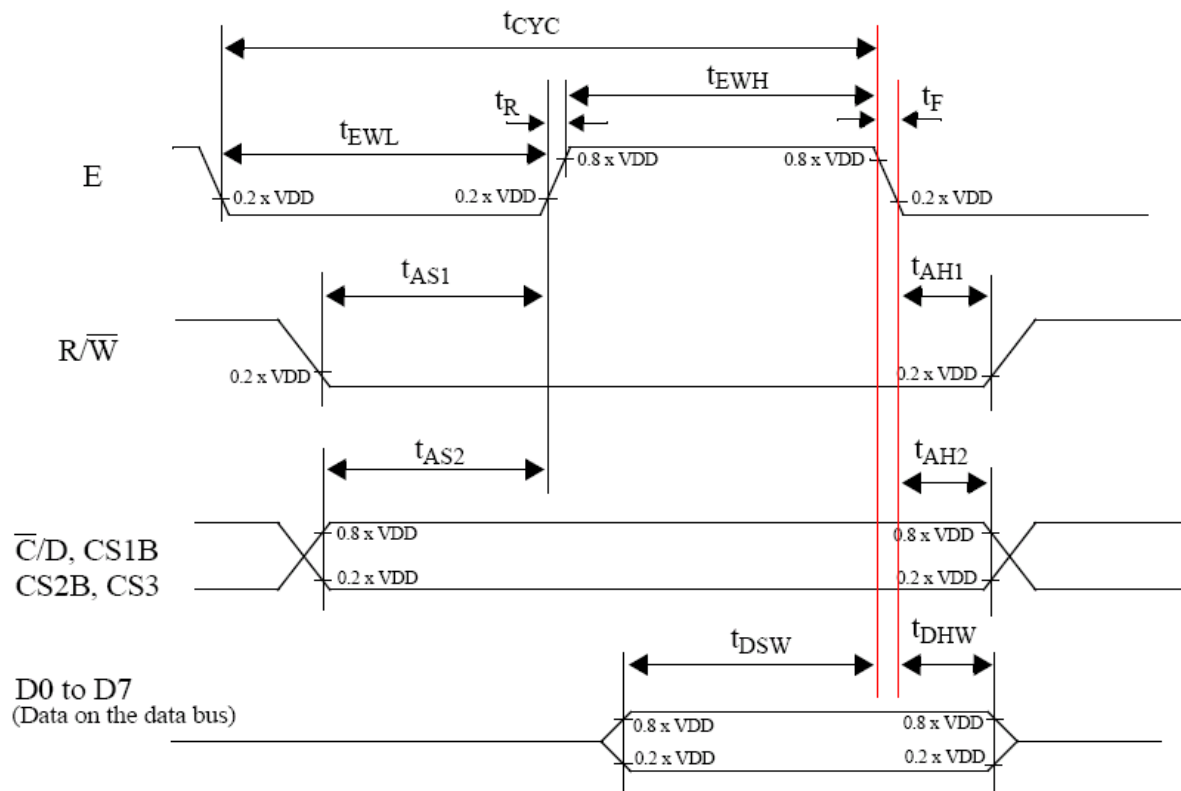
Start line = 4

Figure 2

12.2.2 Timing characteristics

MPU Write Timing

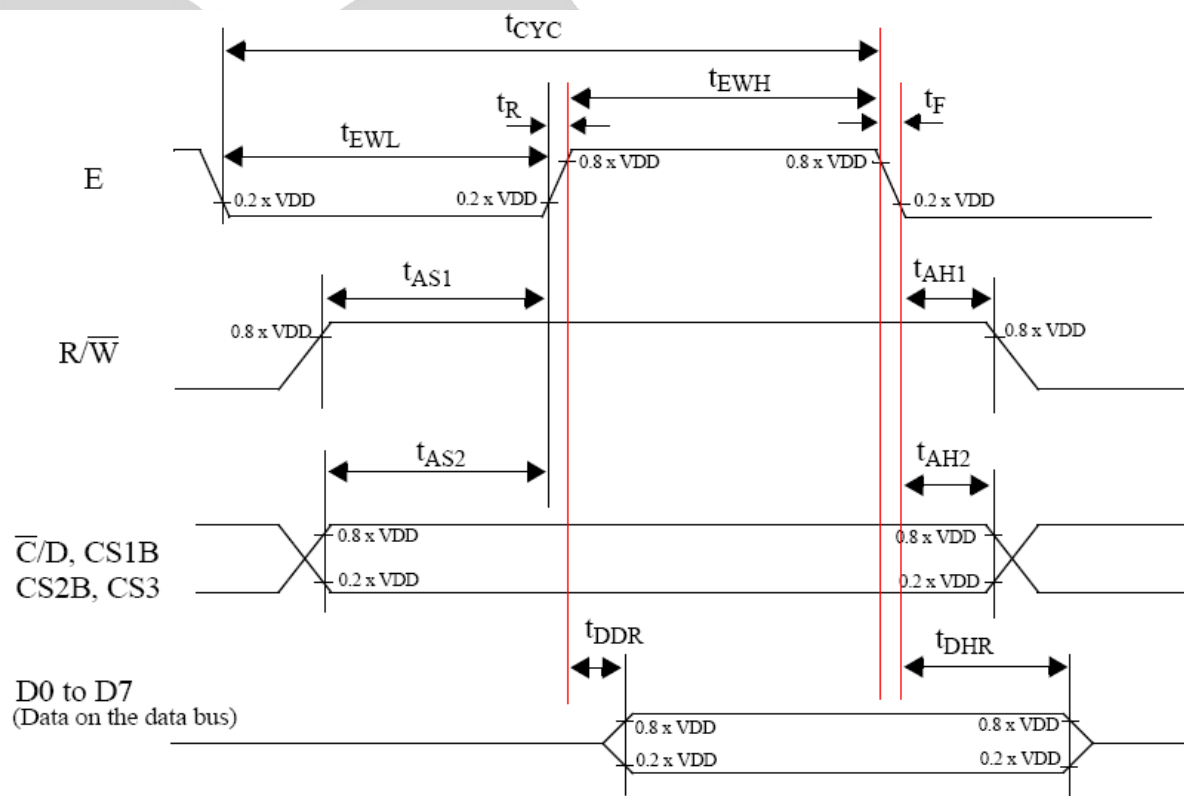
Characteristic	Symbol	Min	Typ	Max	Unit
E cycle	tCYC	1000	—	—	ns
E low level width	tEWL	450	—	—	ns
E high level width	tEWH	450	—	—	ns
E rise time	tR	—	20	—	ns
E fall time	tF	—	20	—	ns
Address set-up time	tAS1	140	—	—	ns
Address hold time	tAH1	10	—	—	ns
Address set-up time	tAS2	140	—	—	ns
Address hold time	tAH2	10	—	—	ns
Data set-up time	tDSW	200	—	—	ns
Data hold time	tDHW	10	—	—	ns



MPU Write Timing

MPU Read Timing

Characteristic	Symbol	Min	Typ	Max	Unit
E cycle	tCYC	1000	—	—	ns
E low level width	tEWL	450	—	—	ns
E high level width	tEWH	450	—	—	ns
E rise time	tR	—	20	—	ns
E fall time	tF	—	20	—	ns
Address set-up time	tAS1	140	—	—	ns
Address hold time	tAH1	20	—	—	ns
Address set-up time	tAS2	140	—	—	ns
Address hold time	tAH2	10	—	—	ns
Data delay time	tDDR	320	—	—	ns
Data hold time	tDHR	10	—	—	ns



MPU Read Timing